

## **TPS3808 Low-Quiescent-Current, Programmable-Delay Supervisory Circuit**

### 1 Features

- Power-On Reset Generator with Adjustable Delay Time: 1.25 ms to 10 s
- Very Low Quiescent Current: 2.4 µA Typical
- High Threshold Accuracy: 0.5% Typ
- Fixed Threshold Voltages for Standard Voltage Rails from 0.9 V to 5 V and Adjustable Voltage Down to 0.4 V Are Available
- Manual Reset ( MR) Input
- Open-Drain RESET Output
- Temperature Range: –40°C to 125°C
- Small SOT-23 and 2-mm × 2-mm WSON Packages

### 2 Applications

- DSP or Microcontroller Applications
- Notebook and Desktop Computers
- PDAs and Hand-Held Products
- Portable and Battery-Powered Products
- FPGA and ASIC Applications

### **3 Description**

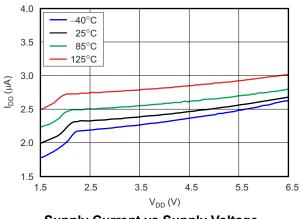
The TPS3808 family of microprocessor supervisory circuits monitors system voltages from 0.4 V to 5 V, asserting an open-drain RESET signal when the SENSE voltage drops below a preset threshold or when the manual reset ( $\overline{MR}$ ) pin drops to a logic low. The RESET output remains low for the user-adjustable delay time after the SENSE voltage and manual reset ( $\overline{MR}$ ) return above the respective thresholds.

The TPS3808 device uses a precision reference to achieve 0.5% threshold accuracy for  $V_{\text{IT}} \leq 3.3$  V. The reset delay time can be set to 20 ms by disconnecting the  $C_{\text{T}}$  pin, 300 ms by connecting the  $C_{\text{T}}$  pin to  $V_{\text{DD}}$  using a resistor, or can be user-adjusted between 1.25 ms and 10 s by connecting the  $C_{\text{T}}$  pin to an external capacitor. The TPS3808 device has a very low typical quiescent current of 2.4  $\mu$ A, so it is well-suited to battery-powered applications. It is available in the SOT-23 and 2-mm × 2-mm WSON packages, and is fully specified over a temperature range of – 40°C to 125°C (T<sub>J</sub>).

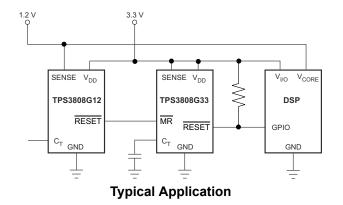
#### **Device Information**

| PART NUMBER | PACKAGE (1) | BODY SIZE (NOM)   |  |  |
|-------------|-------------|-------------------|--|--|
| TPS3808     | SOT-23 (6)  | 2.90 mm x 1.60 mm |  |  |
| 1933000     | WSON (6)    | 2.00 mm x 2.00 mm |  |  |

(1) For all available packages, see the orderable addendum at the end of the data sheet.



Supply Current vs Supply Voltage



An IMPORTANT NOTICE at the end of this data sheet addresses availability, warranty, changes, use in safety-critical applications, intellectual property matters and other important disclaimers. PRODUCTION DATA.



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## **4 Revision History**

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| Cł | nanges from Revision K (October 2015) to Revision L (September 2020)  | Page |
|----|---|------|
| •  | Updated the numbering format for tables, figures and cross-references throughout the document   | 1    |
| Cł | nanges from Revision J (August 2008) to Revision K (October 2015)   | Page |
|    | Added ESD Ratings table, Feature Description section, Device Functional Modes, Application and Implementation section, Power Supply Recommendations section, Layout section, Device and Documentation Support section, and Mechanical, Packaging, and Orderable Information section. Moved Switching Characteristics table, timing diagram, and related truth table | 1    |



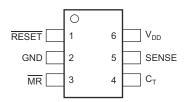
### **5 Device Voltage Thresholds**

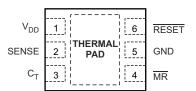
The following table shows the nominal rail to be monitored and the corresponding threshold voltage of the device.

| PART NUMBER | NOMINAL SUPPLY VOLTAGE <sup>(1)</sup> | THRESHOLD VOLTAGE (VIT) |
|-------------|---------------------------------------|-------------------------|
| TPS3808G01  | Adjustable                            | 0.405 V                 |
| TPS3808G09  | 0.9 V                                 | 0.84 V                  |
| TPS3808G12  | 1.2 V                                 | 1.12 V                  |
| TPS3808G125 | 1.25 V                                | 1.16 V                  |
| TPS3808G15  | 1.5 V                                 | 1.40 V                  |
| TPS3808G18  | 1.8 V                                 | 1.67 V                  |
| TPS3808G19  | 1.9 V                                 | 1.77 V                  |
| TPS3808G25  | 2.5 V                                 | 2.33 V                  |
| TPS3808G30  | 3 V                                   | 2.79 V                  |
| TPS3808G33  | 3.3 V                                 | 3.07 V                  |
| TPS3808G50  | 5 V                                   | 4.65 V                  |

(1) Custom threshold voltages from 0.82 V to 3.3 V, 4.4 V to 5 V are available through the use of factory EEPROM programming. Minimum order quantities apply. Contact the factory for details and availability.

## **6** Pin Configuration and Functions









#### Table 6-1. Pin Functions

| PIN             |        |      | 1/0 | DESCRIPTION   |  |  |  |
|-----------------|--------|------|-----|---|--|--|--|
| NAME            | SOT-23 | WSON | 1/0 | DESCRIPTION   |  |  |  |
| Ст              | 4      | 3    | I   | Reset period programming pin. Connecting this pin to $V_{DD}$ through a 40-k $\Omega$ to 200-k $\Omega$ resistor or leaving it open results in fixed delay times (see Section 7.5). Connecting this pin to a ground referenced capacitor $\geq$ 100 pF gives a user-programmable delay time. See Section 8.3.2 for more information.  |  |  |  |
| GND             | 2      | 5    | _   | Ground  |  |  |  |
| MR              | 3      | 4    | I   | Driving the manual reset pin ( $\overline{\text{MR}}$ low asserts $\overline{\text{RESET}}$ $\overline{\text{MR}}$ is internally tied to $V_{\text{DD}}$ by a 90- $k\Omega$ pull-up resistor.   |  |  |  |
| RESET           | 1      | 6    | 0   | RESET is an open-drain output that is driven to a low-impedance state when RESET is asserted (either the SENSE input is lower than the threshold voltage (V <sub>IT</sub> ) or the MRpin is set to a logic low). RESET remains low (asserted) for the reset period after both SENSE is above V <sub>IT</sub> and MR is set to a logic high. A pull-up resistor from 10 k $\Omega$ to 1 M $\Omega$ should be used on this pin, and allows the reset pin to attain voltages higher than V <sub>DD</sub> . |  |  |  |
| SENSE           | 5      | 2    | I   | This pin is connected to the voltage to be monitored. If the voltage at this terminal drops below the threshold voltage $V_{\rm IT}$ , then $\overline{\rm RESET}$ is asserted.   |  |  |  |
| V <sub>DD</sub> | 6      | 1    | I   | Supply voltage. It is good analog design practice to place a 0.1-µF ceramic capacitor lose to this pin.   |  |  |  |
| Thermal<br>Pad  | _      | Pad  | _   | Thermal Pad. Connect to ground plane to enhance thermal performance of package.   |  |  |  |



### **7** Specifications

#### 7.1 Absolute Maximum Ratings

over operating junction temperature range (unless otherwise noted)<sup>(1)</sup>

|             |   | MIN  | MAX                   | UNIT |
|-------------|---|------|-----------------------|------|
| Voltage     | V <sub>DD</sub>   | -0.3 | 7                     | V    |
|             | V <sub>CT</sub>   | -0.3 | V <sub>DD</sub> + 0.3 | V    |
|             | V <sub>RESET</sub> , V <sub>MR</sub> , V <sub>SENSE</sub> | -0.3 | 7                     | V    |
| Current     | RESET pin   | -5   | 5                     | mA   |
| Temperature | Operating junction, $T_{J}^{(2)}$                         | -40  | 150                   | °C   |
|             | Storage, T <sub>stg</sub>                                 | -65  | 150                   | °C   |

(1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) As a result of the low dissipated power in this device, it is assumed that  $T_J = T_A$ .

### 7.2 ESD Ratings

|     |   |       |  | VALUE | UNIT |
|-----|---|-------|--|-------|------|
|     | Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins <sup>(1)</sup> | ±2000 | V  |       |      |
| V ( | V <sub>(ESD)</sub> Electrostatic discharge                                  |       | Charged device model (CDM), per JEDEC specification JESD22-C101, all pins <sup>(2)</sup> | ±500  | v    |

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

### 7.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

|                    |                            | MIN    | NOM MAX         | UNIT |
|--------------------|----------------------------|--------|-----------------|------|
| V <sub>DD</sub>    | Input supply range         | 1.7    | 6.5             | V    |
| V <sub>SENSE</sub> | SENSE pin voltage          | 0      | 6.5             | V    |
| V <sub>(Ct)</sub>  | C <sub>T</sub> pin voltage |        | V <sub>DD</sub> | V    |
| V MR               | MR pin voltage             | 0      | 6.5             | V    |
| V RESET            | RESET pin voltage          | 0      | 6.5             | V    |
| I <sub>RESET</sub> | RESET pin current          | 0.0003 | 5               | mA   |

#### 7.4 Thermal Information

|                       |  | TPS          |            |      |
|-----------------------|--|--------------|------------|------|
|                       | THERMAL METRIC <sup>(1)</sup>                | DBV (SOT-23) | DRV (WSON) | UNIT |
|                       |  | 6 PINS       | 6 PINS     |      |
| R <sub>θJA</sub>      | Junction-to-ambient thermal resistance       | 180.9        | 178.1      | °C/W |
| R <sub>0JC(top)</sub> | Junction-to-case (top) thermal resistance    | 117.8        | 95.6       | °C/W |
| R <sub>θJB</sub>      | Junction-to-board thermal resistance         | 27.8         | 135        | °C/W |
| Ψ <sub>JT</sub>       | Junction-to-top characterization parameter   | 1.12         | 6.3        | °C/W |
| Ψјв                   | Junction-to-board characterization parameter | 27.3         | 136.6      | °C/W |
| R <sub>0JC(bot)</sub> | Junction-to-case (bottom) thermal resistance | N/A          | 7.3        | °C/W |

(1) For more information about traditional and new thermal metrics, see the *Semiconductor and IC Package Thermal Metrics* application report, SPRA953.



### 7.5 Electrical Characteristics

1.7 V  $\leq$  V<sub>DD</sub>  $\leq$  6.5 V, R<sub>LRESET</sub> = 100 k $\Omega$ , C<sub>LRESET</sub> = 50 pF, over operating temperature range (T<sub>J</sub> = -40°C to 125°C), unless otherwise noted. Typical values are at T<sub>J</sub> = 25°C<sup>(1)</sup>.

|                  | PARAMETI                                   | ER                              | TEST CONDITIONS   | MIN                 | TYP   | MAX                 | UNIT     |
|------------------|--|---------------------------------|---|---------------------|-------|---------------------|----------|
| V                | Input aupply range                         |                                 | –40°C < T <sub>J</sub> < 125°C  | 1.7                 |       | 6.5                 | V        |
| V <sub>DD</sub>  | Input supply range                         |                                 | 0°C < T <sub>J</sub> < 85°C   | 1.65                |       | 6.5                 | V        |
| 1                | Supply surrent (surrent                    | into V nin)                     | V <sub>DD</sub> = 3.3 V, RESETnot asserted<br>MR RESET, C <sub>T</sub> open                     |                     | 2.4   | 5                   |          |
| I <sub>DD</sub>  | Supply current (current                    | into v <sub>DD</sub> pin)       | V <sub>DD</sub> = 6.5 V, RESETnot asserted<br>MR RESET, C <sub>T</sub> open                     |                     | 2.7   | 6                   | μA       |
| V                |  | •                               | $1.3 \text{ V} \le \text{V}_{\text{DD}} < 1.8 \text{ V}, \text{I}_{\text{OL}} = 0.4 \text{ mA}$ |                     |       | 0.3                 |          |
| V <sub>OL</sub>  | Low-level output voltage                   | 8                               | $1.8 \text{ V} \le \text{V}_{\text{DD}} \le 6.5 \text{ V}, \text{I}_{\text{OL}} = 1 \text{ mA}$ |                     |       | 0.4                 | V        |
| V <sub>POR</sub> | Power-up reset voltage                     | (2)                             | V <sub>OL</sub> (max) = 0.2 V, I <sub>RESET</sub> = 15 μA                                       |                     |       | 0.8                 |          |
|                  | Negative-going input<br>threshold accuracy | TPS3808G01                      |   | -2%                 | ±1%   | 2%                  |          |
| V <sub>IT</sub>  |  | V <sub>IT</sub> ≤ 3.3 V         |   | -1.5%               | ±0.5% | 1.5%                |          |
|                  |  | 3.3 V < V <sub>IT</sub> ≤ 5.0 V |   | -2%                 | ±1%   | 2%                  |          |
|                  |  | V <sub>IT</sub> ≤ 3.3 V         | –40°C < T <sub>J</sub> < 85°C   | -1.25%              | ±0.5% | 1.25%               |          |
|                  |  | 3.3 V < V <sub>IT</sub> ≤ 5.0 V | –40°C < T <sub>J</sub> < 85°C   | -1.5%               | ±0.5% | 1.5%                |          |
| \ <i>\</i>       |  | TPS3808G01                      |   |                     | 1.5%  | 3%                  | V        |
| V <sub>HYS</sub> | Hysteresis on V <sub>IT</sub> pin          | Fixed versions                  |   |                     | 1%    | 2.5%                | $V_{IT}$ |
| R mr             | MR Internal pullup resis                   | tance                           |   | 70                  | 90    |                     | kΩ       |
|                  | Input current at                           | TPS3808G01                      | V <sub>SENSE</sub> = V <sub>IT</sub>  | -25                 |       | 25                  | nA       |
| ISENSE           | SENSE pin                                  | Fixed versions                  | V <sub>SENSE</sub> = 6.5 V  |                     | 1.7   |                     | μA       |
| I <sub>OH</sub>  | RESET leakage current                      |                                 | V RESET = 6.5 V, RESET not asserted   |                     |       | 300                 | nA       |
| 0                | Input capacitance, any                     | C <sub>T</sub> pin              | $V_{IN} = 0 V$ to $V_{DD}$  |                     | 5     |                     | - 5      |
| C <sub>IN</sub>  | pin  | Other pins                      | V <sub>IN</sub> = 0 V to 6.5 V  |                     | 5     |                     | pF       |
| V <sub>IL</sub>  | MR logic low input                         |                                 |   | 0                   |       | 0.3 V <sub>DD</sub> | V        |
| V <sub>IH</sub>  | MR logic high input                        |                                 |   | 0.7 V <sub>DD</sub> |       | V <sub>DD</sub>     | v        |

(1) The lowest supply voltage (V<sub>DD</sub>) at which  $\overline{\text{RESET}}$  becomes active. T<sub>rise(VDD)</sub>  $\geq$  15 µs/V.

(2) R<sub>LRESET</sub> and C<sub>LRESET</sub> are the resistor and capacitor connected to the RESET pin.



### 7.6 Switching Characteristics

1.7 V ≤ V<sub>DD</sub> ≤ 6.5 V, R<sub>LRESET</sub> = 100 kΩ, C<sub>LRESET</sub> = 50 pF, over operating temperature range (T<sub>J</sub> = −40°C to 125°C), unless otherwise noted. Typical values are at T<sub>J</sub> = 25°C.<sup>(1)</sup>

|                | PARAMETE                      | R                       | TEST CONDITIONS   | MIN  | TYP   | MAX  | UNIT |
|----------------|-------------------------------|-------------------------|---|------|-------|------|------|
|                | Input pulse width to RESET    | SENSE                   | V <sub>IH</sub> = 1.05 V <sub>IT</sub> , V <sub>IL</sub> = 0.95 V <sub>IT</sub> |      | 20    |      |      |
| 1 <sub>w</sub> |                               | MR                      | $V_{IH} = 0.7 V_{DD}, V_{IL} = 0.3 V_{DD}$                                      |      | 0.001 |      | μs   |
|                |                               | C <sub>T</sub> = Open   |   | 12   | 20    | 28   |      |
|                | RESET delay time              | $C_T = V_{DD}$          | See Figure 7-1  | 180  | 300   | 420  | ms   |
| t <sub>d</sub> |                               | C <sub>T</sub> = 100 pF |   | 0.75 | 1.25  | 1.75 |      |
|                |                               | C <sub>T</sub> = 180 nF |   | 0.7  | 1.2   | 1.7  | S    |
|                | Propagation delay             | MR to RESET             | $V_{IH} = 0.7 V_{DD}, V_{IL} = 0.3 V_{DD}$                                      |      | 150   |      | ns   |
|                | High-to-low level RESET delay | SENSE to RESET          | V <sub>IH</sub> = 1.05 V <sub>IT</sub> , V <sub>IL</sub> = 0.95 V <sub>IT</sub> |      | 20    |      | μs   |

(1)  $R_{LRESET}$  and  $C_{LRESET}$  are the resistor and capacitor connected to the RESET pin.

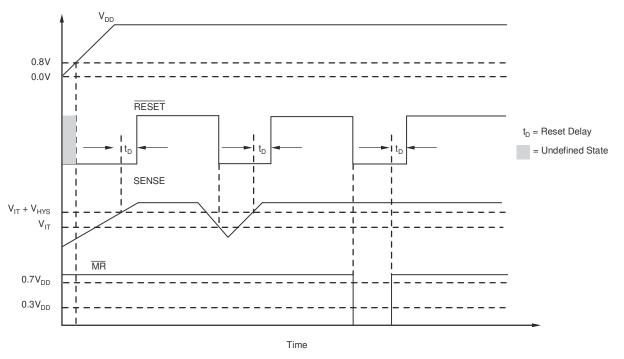
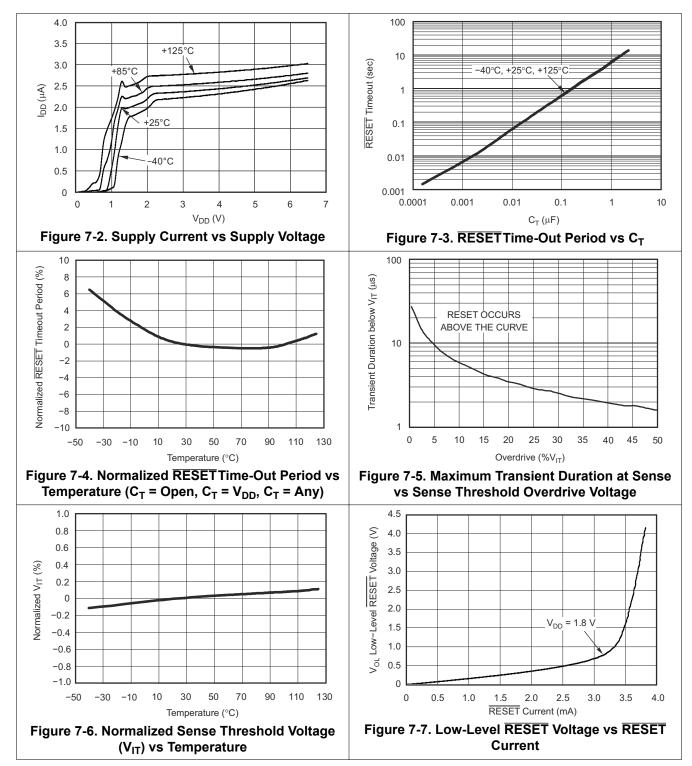


Figure 7-1. TPS3808 Timing Diagram Showing MR and SENSE Reset Timing

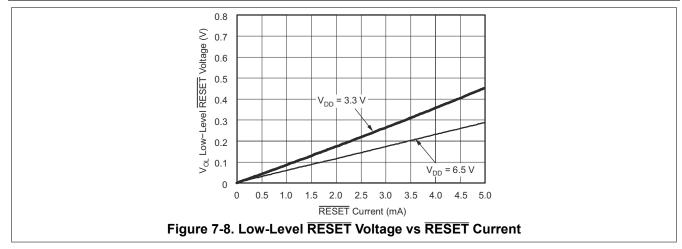


### 7.7 Typical Characteristics

At T<sub>J</sub> = 25°C, V<sub>DD</sub> = 3.3 V, R<sub>LRESET</sub> = 100 k $\Omega$ , and C<sub>LRESET</sub> = 50 pF, unless otherwise noted.







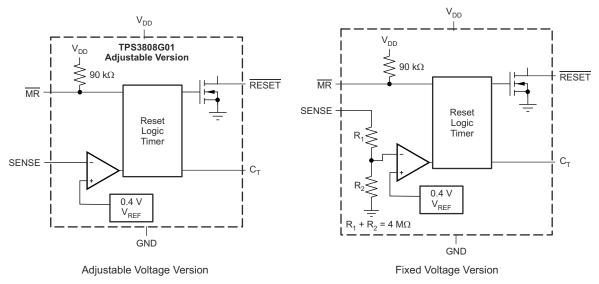


### 8 Detailed Description

#### 8.1 Overview

The TPS3808 microprocessor supervisory product family is designed to assert a  $\overline{\text{RESET}}$  signal when either the SENSE pin voltage drops below V<sub>IT</sub> or the manual reset ( $\overline{\text{MR}}$ ) is driven low. The  $\overline{\text{RESET}}$  output remains asserted for a user-adjustable time after both the manual reset ( $\overline{\text{MR}}$ ) and SENSE voltages return above their respective thresholds.

#### 8.2 Functional Block Diagram



#### 8.3 Feature Description

A broad range of voltage threshold and reset delay time adjustments are available for the TPS3808 device, allowing these devices to be used in a wide array of applications. Reset threshold voltages can be factory-set from 0.82 V to 3.3 V or from 4.4 V to 5 V, while the TPS3808G01 can be set to any voltage above 0.405 V using an external resistor divider. Two preset delay times are also user-selectable: connecting the  $C_T$  pin to  $V_{DD}$  results in a 300-ms reset delay, whereas leaving the  $C_T$  pin open yields a 20-ms reset delay. In addition, connecting a capacitor between  $C_T$  and GND allows the designer to select any reset delay period from 1.25 ms to 10 s.

#### 8.3.1 SENSE Input

The SENSE input provides a pin at which any system voltage can be monitored. If the voltage on this pin drops below  $V_{IT}$ , then  $\overrightarrow{RESET}$  is asserted. The comparator has a built-in hysteresis to ensure smooth  $\overrightarrow{RESET}$  assertions and de-assertions. It is good analog design practice to put a 1-nF to 10-nF bypass capacitor on the SENSE input to reduce sensitivity to transients and layout parasitics.

The TPS3808 device is relatively immune to short negative transients on the SENSE pin. Sensitivity to transients is dependent on threshold overdrive, as shown in (Figure 7-5).

The TPS3808G01 can be used to monitor any voltage rail down to 0.405 V using the circuit shown in Figure 8-1.



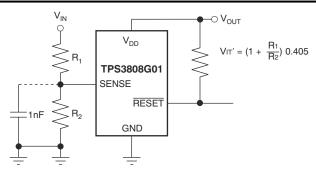


Figure 8-1. Using the TPS3808G01 to Monitor a User-Defined Threshold Voltage

#### 8.3.2 Selecting the RESET Delay Time

The TPS3808 has three options for setting the RESET delay time as shown in Figure 8-2. Figure 8-2 (a) shows the configuration for a fixed 300-ms typical delay time by tying  $C_T$  to  $V_{DD}$ ; a resistor from 40 k $\Omega$  to 200 k $\Omega$  must be used. Supply current is not affected by the choice of resistor. Figure 8-2 (b) shows a fixed 20-ms delay time by leaving the  $C_T$  pin open. Figure 8-2 (c) shows a ground referenced capacitor connected to  $C_T$  for a user-defined program time between 1.25 ms and 10 s.

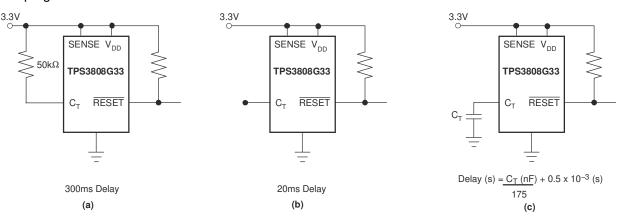


Figure 8-2. Configuration Used to Set the RESET Delay Time

The capacitor  $C_T$  should be  $\ge 100 \text{ pF}$  nominal value in order for the TPS3808xxx to recognize that the capacitor is present. The capacitor value for a given delay time can be calculated using Equation 1.

$$C_{T}(nF) = [t_{D}(s) - 0.5 \times 10^{-3}(s)] \times 175$$

The reset delay time is determined by the time it takes an on-chip precision 220-nA current source to charge the external capacitor to 1.23 V. When a RESET is asserted, the capacitor is discharged. When the RESET conditions are cleared, the internal current source is enabled and begins to charge the external capacitor. When the voltage on this capacitor reaches 1.23 V, RESET is deasserted. Note that a low-leakage type capacitor such as a ceramic should be used, and that stray capacitance around this pin may cause errors in the reset delay time.

(1)

#### 8.3.3 Manual RESET ( MR) Input

The manual reset ( $\overline{\text{MR}}$ ) input allows a processor or other logic circuits to initiate a reset. A logic low (0.3 V<sub>DD</sub>) on  $\overline{\text{MR}}$  causes  $\overline{\text{RESET}}$  to assert. After  $\overline{\text{MR}}$  returns to a logic high and SENSE is above its reset threshold,  $\overline{\text{RESET}}$  is de-asserted after the user-defined reset delay expires. Note that  $\overline{\text{MR}}$  is internally tied to V<sub>DD</sub> using a 90-k $\Omega$  resistor, so this pin can be left unconnected if  $\overline{\text{MR}}$  is not used.

See Figure 8-3 for how  $\overline{\text{MR}}$  can be used to monitor multiple system voltages. Note that if the logic signal driving  $\overline{\text{MR}}$  does not go fully to V<sub>DD</sub>, there is some additional current draw into V<sub>DD</sub> as a result of the internal pullup resistor on  $\overline{\text{MR}}$ . To minimize current draw, a logic-level FET can be used as illustrated in Figure 8-4.

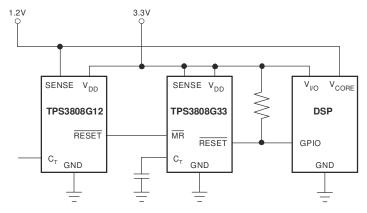
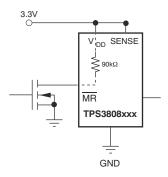


Figure 8-3. Using MR to Monitor Multiple System Voltages



### Figure 8-4. Using an External MOSFET to Minimize I<sub>DD</sub> When MRSignal Does Not Go to V<sub>DD</sub>

### 8.3.4 RESET Output

RESET remains high (unasserted) as long as SENSE is above its threshold ( $V_{IT}$ ) and the manual reset ( $\overline{MR}$ ) is logic high. If either SENSE falls below  $V_{IT}$  or  $\overline{MR}$  is driven low, RESET is asserted, driving the RESET pin to a low impedance.

Once  $\overline{\text{MR}}$  is again logic high and SENSE is above V<sub>IT</sub> + V<sub>HYS</sub> (the threshold hysteresis), a delay circuit is enabled that holds  $\overline{\text{RESET}}$  low for a specified reset delay period. Once the reset delay has expired, the  $\overline{\text{RESET}}$  pin goes to a high impedance state. The pullup resistor from the open-drain  $\overline{\text{RESET}}$  to the supply line can be used to allow the reset signal for the microprocessor to have a voltage higher than V<sub>DD</sub> (up to 6.5 V). The pullup resistor should be no smaller than 10 k $\Omega$  as a result of the finite impedance of the RESET line.



#### 8.4 Device Functional Modes

| lá | Table 8-1. Truth Table  |       |  |  |  |  |  |  |  |  |  |  |
|----|-------------------------|-------|--|--|--|--|--|--|--|--|--|--|
| MR | SENSE > V <sub>IT</sub> | RESET |  |  |  |  |  |  |  |  |  |  |
| L  | 0                       | L     |  |  |  |  |  |  |  |  |  |  |
| L  | 1                       | L     |  |  |  |  |  |  |  |  |  |  |
| Н  | 0                       | L     |  |  |  |  |  |  |  |  |  |  |
| Н  | 1                       | Н     |  |  |  |  |  |  |  |  |  |  |

#### Table 8-1. Truth Table

#### 8.4.1 Normal Operation (V<sub>DD</sub> > V<sub>DD(min)</sub>)

When  $V_{DD}$  is greater than  $V_{DD(min)}$ , the RESET signal is determined by the voltage on the SENSE pin and the logic state of MR.

- MRhigh: When the voltage on V<sub>DD</sub> is greater than 1.7 V for a time of the selected t<sub>D</sub>, the RESET signal corresponds to the voltage on SENSE relative to V<sub>IT</sub>.
- MR low: in this mode, RESET is held low regardless of the value of the SENSE pin.

## 8.4.2 Above Power-On Reset but Less Than $V_{DD(min)}$ ( $V_{POR} < V_{DD} < V_{DD(min)}$ )

When the voltage on  $V_{DD}$  is less than the device  $V_{DD(min)}$  voltage, and greater than the power-on reset voltage ( $V_{POR}$ ), the RESET signal is asserted and low impedance, respectively, regardless of the voltage on the SENSE pin.

#### 8.4.3 Below Power-On Reset (V<sub>DD</sub> < V<sub>POR</sub>)

When the voltage on  $V_{DD}$  is lower than the required voltage ( $V_{POR}$ ) needed to internally pull the asserted output to GND, RESET is undefined and should not be relied upon for proper device function.



### **9** Application and Implementation

#### Note

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

#### 9.1 Application Information

The following sections describe in detail how to properly use this device, depending on the requirements of the final application.

#### 9.2 Typical Application

A typical application of the TPS3808G25 used with a 2.5-V processor is shown in Figure 9-1. The open-drain RESET output is typically connected to the RESET input of a microprocessor. A pullup resistor must be used to hold this line high when RESET is not asserted. The RESET output is undefined for voltage below 0.8 V, but this characteristic is normally not a problem because most microprocessors do not function below this voltage.

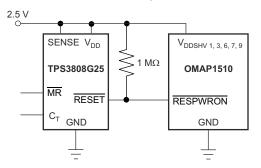


Figure 9-1. Typical Application of the TPS3808 With an OMAP Processor

#### 9.2.1 Design Requirements

The TPS3808 is intended to drive the RESET input of a microprocessor. The RESET pin is pulled high with a 1-M $\Omega$  resistor and the reset delay time is controlled by C<sub>T</sub> depending on the reset requirement times of the microprocessor. In this case, C<sub>T</sub> is left open for a typical reset delay time of 20 ms.

#### 9.2.2 Detailed Design Procedure

The primary constraint for this application is the reset delay time. In this case, because  $C_T$  is open, it is set to 20 ms. A 0.1- $\mu$ F decoupling capacitor is connected to the  $V_{DD}$  pin and a 1-M $\Omega$  resistor is used to pull up the RESET pin high. The  $\overline{MR}$  pin can be connected to an external signal if desired.

#### 9.2.2.1 Immunity to SENSE Pin Voltage Transients

The TPS3808 is relatively immune to short negative transients on the SENSE pin. Sensitivity to transients depends on threshold overdrive. Threshold overdrive is defined by how much the  $V_{SENSE}$  exceeds the specified threshold, and is important to know because the smaller the overdrive, the slower the RESET response. Threshold overdrive is calculated as a percent of the threshold in question, as shown in Equation 2:

Overdrive = 
$$|(V_{SENSE} / V_{IT} - 1) \times 100\%|$$

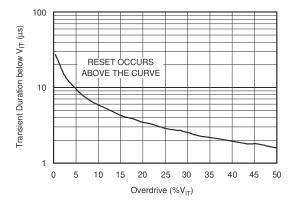
(2)

- where:
- V<sub>IT</sub> is the threshold voltage.

Figure 9-2 shows this relationship.



#### 9.2.3 Application Curve



#### Figure 9-2. Maximum Transient Duration at SENSE vs SENSE Threshold Overdrive Voltage

### **10 Power Supply Recommendations**

These devices are designed to operate from an input supply with a voltage range between 1.7 V and 6.5 V. Use a low-impedance power supply to eliminate inaccuracies caused by current changes during the voltage reference refresh.

#### 11 Layout

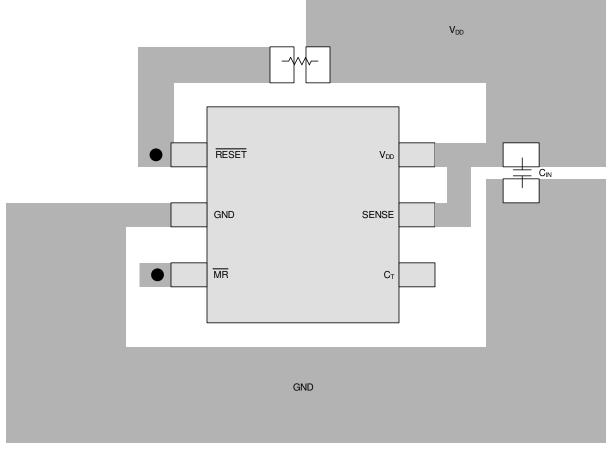
#### **11.1 Layout Guidelines**

Make sure the connection to the  $V_{DD}$  pin is low impedance. Place a 0.1-µF ceramic capacitor near the  $V_{DD}$  pin. If no capacitor is connected to the  $C_T$  pin, parasitic capacitance on this pin should be minimized so the RESET delay time is not adversely affected.

#### **11.2 Layout Example**

The layout example in Figure 11-1 shows how the TPS3808 is laid out on a printed circuit board (PCB) for a 20ms delay.





Vias used to connect pins for application-specific connections

Figure 11-1. Layout Example for a 20-ms Delay



### 12 Device and Documentation Support

#### 12.1 Device Support

#### 12.1.1 Development Support

#### 12.1.1.1 Evaluation Modules

An evaluation module (EVM) is available to assist in the initial circuit performance evaluation using the TPS3808. The TPS3808G01DBVEVM evaluation module (and related user guide) can be requested at the Texas Instruments website through the product folders or purchased directly from the TI eStore.

#### **12.2 Documentation Support**

#### 12.2.1 Related Documentation

The following related documents are available for download at www.ti.com:

- Application note. Optimizing Resistor Dividers at a Comparator Input. Literature number SLVA450.
- Application note. Sensitivity Analysis for Power Supply Design. Literature number SLVA481.
- TPS3808G01DBVEVM Evaluation Module User Guide. Literature number SBVU015.

#### **12.3 Support Resources**

TI E2E<sup>™</sup> support forums are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

Linked content is provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

#### 12.4 Trademarks

TI E2E<sup>™</sup> is a trademark of Texas Instruments.

All other trademarks are the property of their respective owners.

#### 12.5 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

#### 12.6 Glossary

**TI Glossary** This glossary lists and explains terms, acronyms, and definitions.

#### 13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the mostcurrent data available for the designated devices. This data is subject to change without notice and without revision of this document. For browser-based versions of this data sheet, see the left-hand navigation pane.



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### **PACKAGING INFORMATION**

| Orderable Device  | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2) | Lead finish/<br>Ball material | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples |
|-------------------|---------------|--------------|--------------------|------|----------------|-----------------|-------------------------------|----------------------|--------------|-------------------------|---------|
| FX1077            | ACTIVE        | SOT-23       | DBV                | 6    | 3000           | RoHS & Green    | NIPDAU                        | Level-1-260C-UNLIM   | -40 to 125   | AVW                     | Samples |
| HPA00489DRVR      | ACTIVE        | WSON         | DRV                | 6    | 3000           | RoHS & Green    | NIPDAU                        | Level-1-260C-UNLIM   | -40 to 125   | AVW                     | Samples |
| TPS3808G01DBVR    | ACTIVE        | SOT-23       | DBV                | 6    | 3000           | RoHS & Green    | NIPDAU                        | Level-1-260C-UNLIM   | -40 to 125   | AVW                     | Samples |
| TPS3808G01DBVRG4  | ACTIVE        | SOT-23       | DBV                | 6    | 3000           | RoHS & Green    | NIPDAU                        | Level-1-260C-UNLIM   | -40 to 125   | AVW                     | Samples |
| TPS3808G01DBVT    | ACTIVE        | SOT-23       | DBV                | 6    | 250            | RoHS & Green    | NIPDAU                        | Level-1-260C-UNLIM   | -40 to 125   | AVW                     | Samples |
| TPS3808G01DBVTG4  | ACTIVE        | SOT-23       | DBV                | 6    | 250            | RoHS & Green    | NIPDAU                        | Level-1-260C-UNLIM   | -40 to 125   | AVW                     | Samples |
| TPS3808G01DRVR    | ACTIVE        | WSON         | DRV                | 6    | 3000           | RoHS & Green    | NIPDAU                        | Level-1-260C-UNLIM   | -40 to 125   | AVW                     | Samples |
| TPS3808G01DRVRG4  | ACTIVE        | WSON         | DRV                | 6    | 3000           | RoHS & Green    | NIPDAU                        | Level-1-260C-UNLIM   | -40 to 125   | AVW                     | Samples |
| TPS3808G01DRVT    | ACTIVE        | WSON         | DRV                | 6    | 250            | RoHS & Green    | NIPDAU                        | Level-1-260C-UNLIM   | -40 to 125   | AVW                     | Samples |
| TPS3808G09DBVR    | ACTIVE        | SOT-23       | DBV                | 6    | 3000           | RoHS & Green    | NIPDAU                        | Level-1-260C-UNLIM   | -40 to 125   | AVV                     | Samples |
| TPS3808G09DBVRG4  | ACTIVE        | SOT-23       | DBV                | 6    | 3000           | RoHS & Green    | NIPDAU                        | Level-1-260C-UNLIM   | -40 to 125   | AVV                     | Samples |
| TPS3808G09DBVT    | ACTIVE        | SOT-23       | DBV                | 6    | 250            | RoHS & Green    | NIPDAU                        | Level-1-260C-UNLIM   | -40 to 125   | AVV                     | Samples |
| TPS3808G09DBVTG4  | ACTIVE        | SOT-23       | DBV                | 6    | 250            | RoHS & Green    | NIPDAU                        | Level-1-260C-UNLIM   | -40 to 125   | AVV                     | Samples |
| TPS3808G125DBVR   | ACTIVE        | SOT-23       | DBV                | 6    | 3000           | RoHS & Green    | NIPDAU                        | Level-1-260C-UNLIM   | -40 to 125   | CAC                     | Samples |
| TPS3808G125DBVT   | ACTIVE        | SOT-23       | DBV                | 6    | 250            | RoHS & Green    | NIPDAU                        | Level-1-260C-UNLIM   | -40 to 125   | CAC                     | Samples |
| TPS3808G125DBVTG4 | ACTIVE        | SOT-23       | DBV                | 6    | 250            | RoHS & Green    | NIPDAU                        | Level-1-260C-UNLIM   | -40 to 125   | CAC                     | Samples |
| TPS3808G12DBVR    | ACTIVE        | SOT-23       | DBV                | 6    | 3000           | RoHS & Green    | NIPDAU                        | Level-1-260C-UNLIM   | -40 to 125   | AVY                     | Samples |
| TPS3808G12DBVRG4  | ACTIVE        | SOT-23       | DBV                | 6    | 3000           | RoHS & Green    | NIPDAU                        | Level-1-260C-UNLIM   | -40 to 125   | AVY                     | Samples |
| TPS3808G12DBVT    | ACTIVE        | SOT-23       | DBV                | 6    | 250            | RoHS & Green    | NIPDAU                        | Level-1-260C-UNLIM   | -40 to 125   | AVY                     | Samples |
| TPS3808G12DBVTG4  | ACTIVE        | SOT-23       | DBV                | 6    | 250            | RoHS & Green    | NIPDAU                        | Level-1-260C-UNLIM   | -40 to 125   | AVY                     | Samples |



## PACKAGE OPTION ADDENDUM

10-Dec-2020

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2) | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples |
|------------------|---------------|--------------|--------------------|------|----------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|---------|
| TPS3808G12DRVR   | ACTIVE        | WSON         | DRV                | 6    | 3000           | RoHS & Green    | NIPDAU   NIPDAUAG                    | Level-1-260C-UNLIM   | -40 to 125   | AVY                     | Samples |
| TPS3808G12DRVT   | ACTIVE        | WSON         | DRV                | 6    | 250            | RoHS & Green    | NIPDAU   NIPDAUAG                    | Level-1-260C-UNLIM   | -40 to 125   | AVY                     | Samples |
| TPS3808G12DRVTG4 | ACTIVE        | WSON         | DRV                | 6    | 250            | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | AVY                     | Samples |
| TPS3808G15DBVR   | ACTIVE        | SOT-23       | DBV                | 6    | 3000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | AVS                     | Samples |
| TPS3808G15DBVRG4 | ACTIVE        | SOT-23       | DBV                | 6    | 3000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | AVS                     | Samples |
| TPS3808G15DBVT   | ACTIVE        | SOT-23       | DBV                | 6    | 250            | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | AVS                     | Samples |
| TPS3808G15DBVTG4 | ACTIVE        | SOT-23       | DBV                | 6    | 250            | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | AVS                     | Samples |
| TPS3808G15DRVR   | ACTIVE        | WSON         | DRV                | 6    | 3000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | AVS                     | Samples |
| TPS3808G15DRVT   | ACTIVE        | WSON         | DRV                | 6    | 250            | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | AVS                     | Samples |
| TPS3808G18DBVR   | ACTIVE        | SOT-23       | DBV                | 6    | 3000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | AVR                     | Samples |
| TPS3808G18DBVRG4 | ACTIVE        | SOT-23       | DBV                | 6    | 3000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | AVR                     | Samples |
| TPS3808G18DBVT   | ACTIVE        | SOT-23       | DBV                | 6    | 250            | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | AVR                     | Samples |
| TPS3808G18DBVTG4 | ACTIVE        | SOT-23       | DBV                | 6    | 250            | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | AVR                     | Samples |
| TPS3808G18DRVR   | ACTIVE        | WSON         | DRV                | 6    | 3000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | AVR                     | Samples |
| TPS3808G18DRVT   | ACTIVE        | WSON         | DRV                | 6    | 250            | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | AVR                     | Samples |
| TPS3808G19DBVR   | ACTIVE        | SOT-23       | DBV                | 6    | 3000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | CHP                     | Samples |
| TPS3808G19DBVT   | ACTIVE        | SOT-23       | DBV                | 6    | 250            | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | CHP                     | Samples |
| TPS3808G25DBVR   | ACTIVE        | SOT-23       | DBV                | 6    | 3000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | AVQ                     | Samples |
| TPS3808G25DBVRG4 | ACTIVE        | SOT-23       | DBV                | 6    | 3000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | AVQ                     | Samples |
| TPS3808G25DBVT   | ACTIVE        | SOT-23       | DBV                | 6    | 250            | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | AVQ                     | Samples |
| TPS3808G25DBVTG4 | ACTIVE        | SOT-23       | DBV                | 6    | 250            | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | AVQ                     | Samples |



## PACKAGE OPTION ADDENDUM

10-Dec-2020

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2) | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples |
|------------------|---------------|--------------|--------------------|------|----------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|---------|
| TPS3808G25DRVR   | ACTIVE        | WSON         | DRV                | 6    | 3000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | AVQ                     | Samples |
| TPS3808G25DRVRG4 | ACTIVE        | WSON         | DRV                | 6    | 3000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | AVQ                     | Samples |
| TPS3808G25DRVT   | ACTIVE        | WSON         | DRV                | 6    | 250            | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | AVQ                     | Samples |
| TPS3808G25DRVTG4 | ACTIVE        | WSON         | DRV                | 6    | 250            | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | AVQ                     | Samples |
| TPS3808G30DBVR   | ACTIVE        | SOT-23       | DBV                | 6    | 3000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | AVP                     | Samples |
| TPS3808G30DBVRG4 | ACTIVE        | SOT-23       | DBV                | 6    | 3000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | AVP                     | Samples |
| TPS3808G30DBVT   | ACTIVE        | SOT-23       | DBV                | 6    | 250            | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | AVP                     | Samples |
| TPS3808G30DBVTG4 | ACTIVE        | SOT-23       | DBV                | 6    | 250            | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | AVP                     | Samples |
| TPS3808G30DRVR   | ACTIVE        | WSON         | DRV                | 6    | 3000           | RoHS & Green    | NIPDAU   NIPDAUAG                    | Level-1-260C-UNLIM   | -40 to 125   | AVP                     | Samples |
| TPS3808G30DRVT   | ACTIVE        | WSON         | DRV                | 6    | 250            | RoHS & Green    | NIPDAU   NIPDAUAG                    | Level-1-260C-UNLIM   | -40 to 125   | AVP                     | Samples |
| TPS3808G33DBVR   | ACTIVE        | SOT-23       | DBV                | 6    | 3000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | AVO                     | Samples |
| TPS3808G33DBVRG4 | ACTIVE        | SOT-23       | DBV                | 6    | 3000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | AVO                     | Samples |
| TPS3808G33DBVT   | ACTIVE        | SOT-23       | DBV                | 6    | 250            | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | AVO                     | Samples |
| TPS3808G33DBVTG4 | ACTIVE        | SOT-23       | DBV                | 6    | 250            | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | AVO                     | Samples |
| TPS3808G33DRVR   | ACTIVE        | WSON         | DRV                | 6    | 3000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | SEC                     | Samples |
| TPS3808G33DRVT   | ACTIVE        | WSON         | DRV                | 6    | 250            | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | SEC                     | Samples |
| TPS3808G50DBVR   | ACTIVE        | SOT-23       | DBV                | 6    | 3000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | AVN                     | Samples |
| TPS3808G50DBVRG4 | ACTIVE        | SOT-23       | DBV                | 6    | 3000           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | AVN                     | Samples |
| TPS3808G50DBVT   | ACTIVE        | SOT-23       | DBV                | 6    | 250            | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | AVN                     | Samples |
| TPS3808G50DBVTG4 | ACTIVE        | SOT-23       | DBV                | 6    | 250            | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | AVN                     | Samples |

<sup>(1)</sup> The marketing status values are defined as follows:



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ACTIVE: Product device recommended for new designs. LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect. NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption. **Green:** TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

#### **OTHER QUALIFIED VERSIONS OF TPS3808 :**

Automotive: TPS3808-Q1

Enhanced Product: TPS3808-EP

NOTE: Qualified Version Definitions:

Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects



10-Dec-2020

• Enhanced Product - Supports Defense, Aerospace and Medical Applications

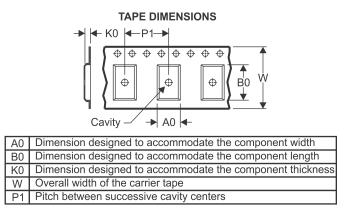
## **PACKAGE MATERIALS INFORMATION**

Texas **NSTRUMENTS** 

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### **TAPE AND REEL INFORMATION**





## QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



| Device          | Package<br>Type | Package<br>Drawing | Pins | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|-----------------|-----------------|--------------------|------|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| TPS3808G01DBVR  | SOT-23          | DBV                | 6    | 3000 | 180.0                    | 8.4                      | 3.2        | 3.2        | 1.4        | 4.0        | 8.0       | Q3               |
| TPS3808G01DBVT  | SOT-23          | DBV                | 6    | 250  | 180.0                    | 8.4                      | 3.2        | 3.2        | 1.4        | 4.0        | 8.0       | Q3               |
| TPS3808G01DRVR  | WSON            | DRV                | 6    | 3000 | 178.0                    | 8.4                      | 2.25       | 2.25       | 1.0        | 4.0        | 8.0       | Q2               |
| TPS3808G01DRVT  | WSON            | DRV                | 6    | 250  | 179.0                    | 8.4                      | 2.2        | 2.2        | 1.2        | 4.0        | 8.0       | Q2               |
| TPS3808G01DRVT  | WSON            | DRV                | 6    | 250  | 178.0                    | 8.4                      | 2.25       | 2.25       | 1.0        | 4.0        | 8.0       | Q2               |
| TPS3808G09DBVR  | SOT-23          | DBV                | 6    | 3000 | 180.0                    | 8.4                      | 3.2        | 3.2        | 1.4        | 4.0        | 8.0       | Q3               |
| TPS3808G09DBVR  | SOT-23          | DBV                | 6    | 3000 | 178.0                    | 9.0                      | 3.23       | 3.17       | 1.37       | 4.0        | 8.0       | Q3               |
| TPS3808G09DBVT  | SOT-23          | DBV                | 6    | 250  | 178.0                    | 9.0                      | 3.23       | 3.17       | 1.37       | 4.0        | 8.0       | Q3               |
| TPS3808G09DBVT  | SOT-23          | DBV                | 6    | 250  | 180.0                    | 8.4                      | 3.2        | 3.2        | 1.4        | 4.0        | 8.0       | Q3               |
| TPS3808G125DBVR | SOT-23          | DBV                | 6    | 3000 | 179.0                    | 8.4                      | 3.2        | 3.2        | 1.4        | 4.0        | 8.0       | Q3               |
| TPS3808G125DBVT | SOT-23          | DBV                | 6    | 250  | 179.0                    | 8.4                      | 3.2        | 3.2        | 1.4        | 4.0        | 8.0       | Q3               |
| TPS3808G12DBVR  | SOT-23          | DBV                | 6    | 3000 | 178.0                    | 9.0                      | 3.23       | 3.17       | 1.37       | 4.0        | 8.0       | Q3               |
| TPS3808G12DBVT  | SOT-23          | DBV                | 6    | 250  | 178.0                    | 9.0                      | 3.23       | 3.17       | 1.37       | 4.0        | 8.0       | Q3               |
| TPS3808G12DRVR  | WSON            | DRV                | 6    | 3000 | 178.0                    | 8.4                      | 2.25       | 2.25       | 1.0        | 4.0        | 8.0       | Q2               |
| TPS3808G12DRVR  | WSON            | DRV                | 6    | 3000 | 179.0                    | 8.4                      | 2.2        | 2.2        | 1.2        | 4.0        | 8.0       | Q2               |
| TPS3808G12DRVT  | WSON            | DRV                | 6    | 250  | 179.0                    | 8.4                      | 2.2        | 2.2        | 1.2        | 4.0        | 8.0       | Q2               |
| TPS3808G12DRVT  | WSON            | DRV                | 6    | 250  | 178.0                    | 8.4                      | 2.25       | 2.25       | 1.0        | 4.0        | 8.0       | Q2               |
| TPS3808G15DBVR  | SOT-23          | DBV                | 6    | 3000 | 178.0                    | 9.0                      | 3.23       | 3.17       | 1.37       | 4.0        | 8.0       | Q3               |

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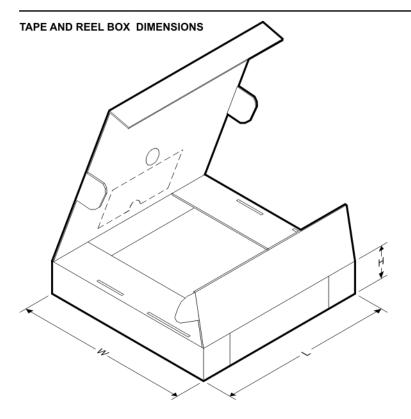
| Device         | Package<br>Type | Package<br>Drawing | Pins | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|----------------|-----------------|--------------------|------|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| TPS3808G15DBVT | SOT-23          | DBV                | 6    | 250  | 178.0                    | 9.0                      | 3.23       | 3.17       | 1.37       | 4.0        | 8.0       | Q3               |
| TPS3808G15DRVR | WSON            | DRV                | 6    | 3000 | 179.0                    | 8.4                      | 2.2        | 2.2        | 1.2        | 4.0        | 8.0       | Q2               |
| TPS3808G15DRVT | WSON            | DRV                | 6    | 250  | 179.0                    | 8.4                      | 2.2        | 2.2        | 1.2        | 4.0        | 8.0       | Q2               |
| TPS3808G18DBVR | SOT-23          | DBV                | 6    | 3000 | 180.0                    | 8.4                      | 3.2        | 3.2        | 1.4        | 4.0        | 8.0       | Q3               |
| TPS3808G18DBVR | SOT-23          | DBV                | 6    | 3000 | 178.0                    | 9.0                      | 3.23       | 3.17       | 1.37       | 4.0        | 8.0       | Q3               |
| TPS3808G18DBVT | SOT-23          | DBV                | 6    | 250  | 180.0                    | 8.4                      | 3.2        | 3.2        | 1.4        | 4.0        | 8.0       | Q3               |
| TPS3808G18DBVT | SOT-23          | DBV                | 6    | 250  | 178.0                    | 9.0                      | 3.23       | 3.17       | 1.37       | 4.0        | 8.0       | Q3               |
| TPS3808G18DRVR | WSON            | DRV                | 6    | 3000 | 179.0                    | 8.4                      | 2.2        | 2.2        | 1.2        | 4.0        | 8.0       | Q2               |
| TPS3808G18DRVT | WSON            | DRV                | 6    | 250  | 179.0                    | 8.4                      | 2.2        | 2.2        | 1.2        | 4.0        | 8.0       | Q2               |
| TPS3808G19DBVR | SOT-23          | DBV                | 6    | 3000 | 178.0                    | 9.0                      | 3.23       | 3.17       | 1.37       | 4.0        | 8.0       | Q3               |
| TPS3808G19DBVT | SOT-23          | DBV                | 6    | 250  | 178.0                    | 9.0                      | 3.23       | 3.17       | 1.37       | 4.0        | 8.0       | Q3               |
| TPS3808G25DBVR | SOT-23          | DBV                | 6    | 3000 | 178.0                    | 9.0                      | 3.23       | 3.17       | 1.37       | 4.0        | 8.0       | Q3               |
| TPS3808G25DBVT | SOT-23          | DBV                | 6    | 250  | 178.0                    | 9.0                      | 3.23       | 3.17       | 1.37       | 4.0        | 8.0       | Q3               |
| TPS3808G25DRVR | WSON            | DRV                | 6    | 3000 | 179.0                    | 8.4                      | 2.2        | 2.2        | 1.2        | 4.0        | 8.0       | Q2               |
| TPS3808G25DRVT | WSON            | DRV                | 6    | 250  | 179.0                    | 8.4                      | 2.2        | 2.2        | 1.2        | 4.0        | 8.0       | Q2               |
| TPS3808G30DBVR | SOT-23          | DBV                | 6    | 3000 | 180.0                    | 8.4                      | 3.2        | 3.2        | 1.4        | 4.0        | 8.0       | Q3               |
| TPS3808G30DBVR | SOT-23          | DBV                | 6    | 3000 | 178.0                    | 9.0                      | 3.23       | 3.17       | 1.37       | 4.0        | 8.0       | Q3               |
| TPS3808G30DBVT | SOT-23          | DBV                | 6    | 250  | 178.0                    | 9.0                      | 3.23       | 3.17       | 1.37       | 4.0        | 8.0       | Q3               |
| TPS3808G30DBVT | SOT-23          | DBV                | 6    | 250  | 180.0                    | 8.4                      | 3.2        | 3.2        | 1.4        | 4.0        | 8.0       | Q3               |
| TPS3808G30DRVR | WSON            | DRV                | 6    | 3000 | 178.0                    | 8.4                      | 2.25       | 2.25       | 1.0        | 4.0        | 8.0       | Q2               |
| TPS3808G30DRVR | WSON            | DRV                | 6    | 3000 | 179.0                    | 8.4                      | 2.2        | 2.2        | 1.2        | 4.0        | 8.0       | Q2               |
| TPS3808G30DRVT | WSON            | DRV                | 6    | 250  | 178.0                    | 8.4                      | 2.25       | 2.25       | 1.0        | 4.0        | 8.0       | Q2               |
| TPS3808G30DRVT | WSON            | DRV                | 6    | 250  | 179.0                    | 8.4                      | 2.2        | 2.2        | 1.2        | 4.0        | 8.0       | Q2               |
| TPS3808G33DBVR | SOT-23          | DBV                | 6    | 3000 | 178.0                    | 9.0                      | 3.23       | 3.17       | 1.37       | 4.0        | 8.0       | Q3               |
| TPS3808G33DBVT | SOT-23          | DBV                | 6    | 250  | 178.0                    | 9.0                      | 3.23       | 3.17       | 1.37       | 4.0        | 8.0       | Q3               |
| TPS3808G33DRVR | WSON            | DRV                | 6    | 3000 | 179.0                    | 8.4                      | 2.2        | 2.2        | 1.2        | 4.0        | 8.0       | Q2               |
| TPS3808G33DRVT | WSON            | DRV                | 6    | 250  | 179.0                    | 8.4                      | 2.2        | 2.2        | 1.2        | 4.0        | 8.0       | Q2               |
| TPS3808G50DBVR | SOT-23          | DBV                | 6    | 3000 | 178.0                    | 9.0                      | 3.23       | 3.17       | 1.37       | 4.0        | 8.0       | Q3               |
| TPS3808G50DBVT | SOT-23          | DBV                | 6    | 250  | 178.0                    | 9.0                      | 3.23       | 3.17       | 1.37       | 4.0        | 8.0       | Q3               |



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| *All dimensions are nominal |              |                 |      |      | _           |            | -           |
|-----------------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| Device                      | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
| TPS3808G01DBVR              | SOT-23       | DBV             | 6    | 3000 | 210.0       | 185.0      | 35.0        |
| TPS3808G01DBVT              | SOT-23       | DBV             | 6    | 250  | 210.0       | 185.0      | 35.0        |
| TPS3808G01DRVR              | WSON         | DRV             | 6    | 3000 | 205.0       | 200.0      | 33.0        |
| TPS3808G01DRVT              | WSON         | DRV             | 6    | 250  | 203.0       | 203.0      | 35.0        |
| TPS3808G01DRVT              | WSON         | DRV             | 6    | 250  | 205.0       | 200.0      | 33.0        |
| TPS3808G09DBVR              | SOT-23       | DBV             | 6    | 3000 | 210.0       | 185.0      | 35.0        |
| TPS3808G09DBVR              | SOT-23       | DBV             | 6    | 3000 | 180.0       | 180.0      | 18.0        |
| TPS3808G09DBVT              | SOT-23       | DBV             | 6    | 250  | 180.0       | 180.0      | 18.0        |
| TPS3808G09DBVT              | SOT-23       | DBV             | 6    | 250  | 210.0       | 185.0      | 35.0        |
| TPS3808G125DBVR             | SOT-23       | DBV             | 6    | 3000 | 200.0       | 183.0      | 25.0        |
| TPS3808G125DBVT             | SOT-23       | DBV             | 6    | 250  | 200.0       | 183.0      | 25.0        |
| TPS3808G12DBVR              | SOT-23       | DBV             | 6    | 3000 | 180.0       | 180.0      | 18.0        |
| TPS3808G12DBVT              | SOT-23       | DBV             | 6    | 250  | 180.0       | 180.0      | 18.0        |
| TPS3808G12DRVR              | WSON         | DRV             | 6    | 3000 | 205.0       | 200.0      | 33.0        |
| TPS3808G12DRVR              | WSON         | DRV             | 6    | 3000 | 200.0       | 183.0      | 25.0        |
| TPS3808G12DRVT              | WSON         | DRV             | 6    | 250  | 203.0       | 203.0      | 35.0        |
| TPS3808G12DRVT              | WSON         | DRV             | 6    | 250  | 205.0       | 200.0      | 33.0        |
| TPS3808G15DBVR              | SOT-23       | DBV             | 6    | 3000 | 180.0       | 180.0      | 18.0        |
| TPS3808G15DBVT              | SOT-23       | DBV             | 6    | 250  | 180.0       | 180.0      | 18.0        |
| TPS3808G15DRVR              | WSON         | DRV             | 6    | 3000 | 200.0       | 183.0      | 25.0        |

## PACKAGE MATERIALS INFORMATION



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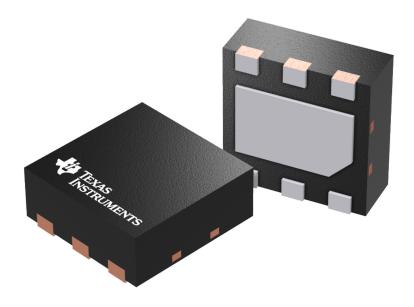
| Device         | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TPS3808G15DRVT | WSON         | DRV             | 6    | 250  | 200.0       | 183.0      | 25.0        |
| TPS3808G18DBVR | SOT-23       | DBV             | 6    | 3000 | 210.0       | 185.0      | 35.0        |
| TPS3808G18DBVR | SOT-23       | DBV             | 6    | 3000 | 180.0       | 180.0      | 18.0        |
| TPS3808G18DBVT | SOT-23       | DBV             | 6    | 250  | 210.0       | 185.0      | 35.0        |
| TPS3808G18DBVT | SOT-23       | DBV             | 6    | 250  | 180.0       | 180.0      | 18.0        |
| TPS3808G18DRVR | WSON         | DRV             | 6    | 3000 | 200.0       | 183.0      | 25.0        |
| TPS3808G18DRVT | WSON         | DRV             | 6    | 250  | 200.0       | 183.0      | 25.0        |
| TPS3808G19DBVR | SOT-23       | DBV             | 6    | 3000 | 180.0       | 180.0      | 18.0        |
| TPS3808G19DBVT | SOT-23       | DBV             | 6    | 250  | 180.0       | 180.0      | 18.0        |
| TPS3808G25DBVR | SOT-23       | DBV             | 6    | 3000 | 180.0       | 180.0      | 18.0        |
| TPS3808G25DBVT | SOT-23       | DBV             | 6    | 250  | 180.0       | 180.0      | 18.0        |
| TPS3808G25DRVR | WSON         | DRV             | 6    | 3000 | 203.0       | 203.0      | 35.0        |
| TPS3808G25DRVT | WSON         | DRV             | 6    | 250  | 200.0       | 183.0      | 25.0        |
| TPS3808G30DBVR | SOT-23       | DBV             | 6    | 3000 | 210.0       | 185.0      | 35.0        |
| TPS3808G30DBVR | SOT-23       | DBV             | 6    | 3000 | 180.0       | 180.0      | 18.0        |
| TPS3808G30DBVT | SOT-23       | DBV             | 6    | 250  | 180.0       | 180.0      | 18.0        |
| TPS3808G30DBVT | SOT-23       | DBV             | 6    | 250  | 210.0       | 185.0      | 35.0        |
| TPS3808G30DRVR | WSON         | DRV             | 6    | 3000 | 205.0       | 200.0      | 33.0        |
| TPS3808G30DRVR | WSON         | DRV             | 6    | 3000 | 203.0       | 203.0      | 35.0        |
| TPS3808G30DRVT | WSON         | DRV             | 6    | 250  | 205.0       | 200.0      | 33.0        |
| TPS3808G30DRVT | WSON         | DRV             | 6    | 250  | 203.0       | 203.0      | 35.0        |
| TPS3808G33DBVR | SOT-23       | DBV             | 6    | 3000 | 180.0       | 180.0      | 18.0        |
| TPS3808G33DBVT | SOT-23       | DBV             | 6    | 250  | 180.0       | 180.0      | 18.0        |
| TPS3808G33DRVR | WSON         | DRV             | 6    | 3000 | 200.0       | 183.0      | 25.0        |
| TPS3808G33DRVT | WSON         | DRV             | 6    | 250  | 200.0       | 183.0      | 25.0        |
| TPS3808G50DBVR | SOT-23       | DBV             | 6    | 3000 | 180.0       | 180.0      | 18.0        |
| TPS3808G50DBVT | SOT-23       | DBV             | 6    | 250  | 180.0       | 180.0      | 18.0        |

## **DRV 6**

## **GENERIC PACKAGE VIEW**

# WSON - 0.8 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



4206925/F

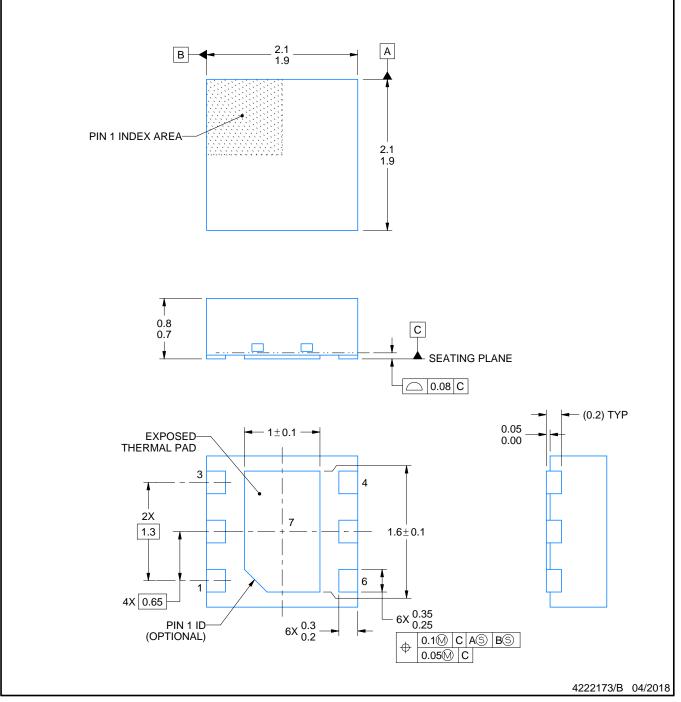
# **DRV0006A**



# **PACKAGE OUTLINE**

## WSON - 0.8 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.2. This drawing is subject to change without notice.3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

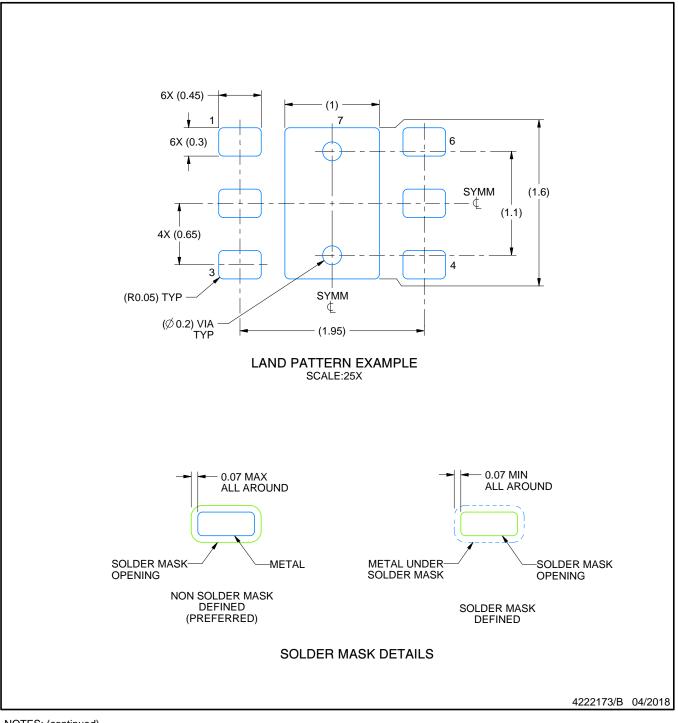


# **DRV0006A**

# **EXAMPLE BOARD LAYOUT**

### WSON - 0.8 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



NOTES: (continued)

4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).

5. Vias are optional depending on application, refer to device data sheet. If some or all are implemented, recommended via locations are shown.



# **DRV0006A**

# **EXAMPLE STENCIL DESIGN**

## WSON - 0.8 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



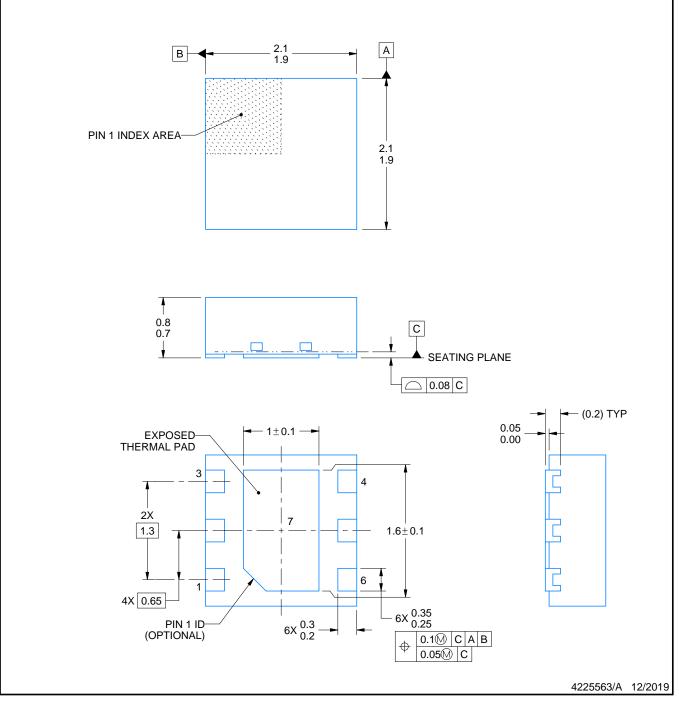
# **DRV0006D**



# **PACKAGE OUTLINE**

## WSON - 0.8 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.2. This drawing is subject to change without notice.3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

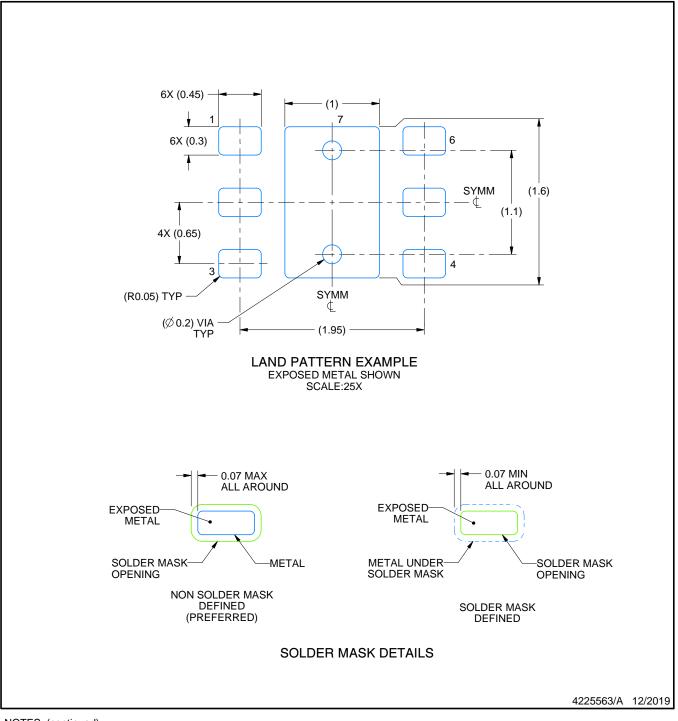


## **DRV0006D**

# **EXAMPLE BOARD LAYOUT**

### WSON - 0.8 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



NOTES: (continued)

4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).

5. Vias are optional depending on application, refer to device data sheet. If some or all are implemented, recommended via locations are shown.

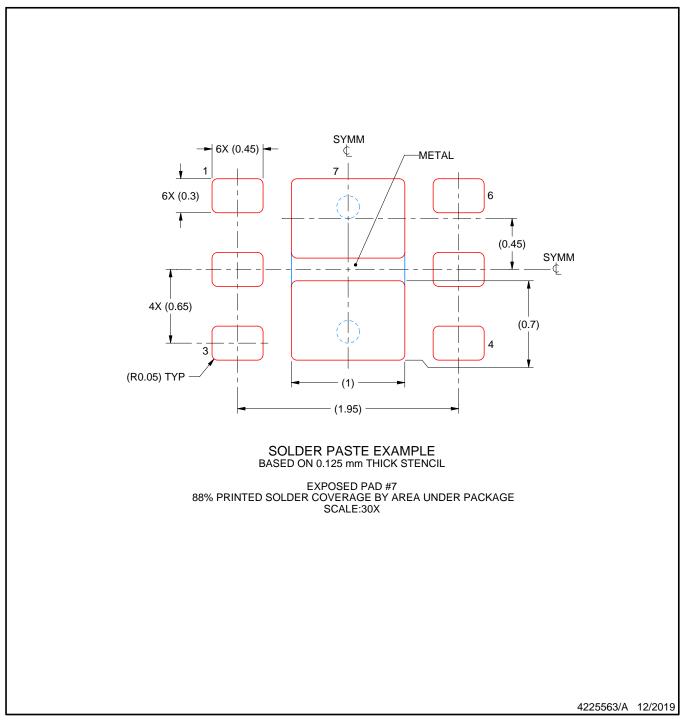


## **DRV0006D**

# **EXAMPLE STENCIL DESIGN**

## WSON - 0.8 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



# **DBV0006A**



## **PACKAGE OUTLINE**

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.2. This drawing is subject to change without notice.3. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.25 per side.

- 4. Leads 1,2,3 may be wider than leads 4,5,6 for package orientation.
- 5. Refernce JEDEC MO-178.

# **DBV0006A**

# **EXAMPLE BOARD LAYOUT**

## SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

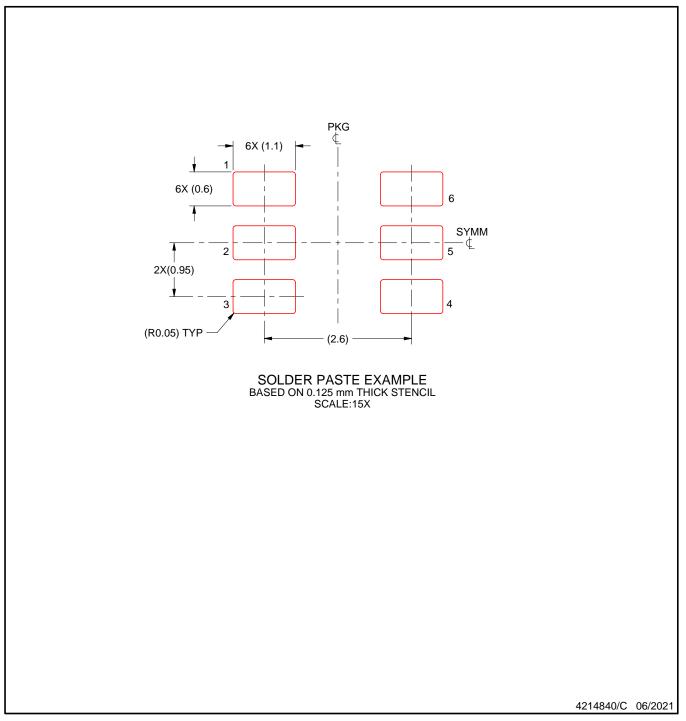


## **DBV0006A**

# **EXAMPLE STENCIL DESIGN**

## SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

9. Board assembly site may have different recommendations for stencil design.



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